Features:

- ◇ PLCC-2 package.
- \diamond White package.
- \diamond Optical indicator.
- \diamond Colorless clear window.
- $\diamond~$ Ideal for backlight and light pipe application.
- \diamond Inter reflector.
- \diamond Wide viewing angle.
- ◇ Suitable for automatic placement equipment.
- \diamond Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- ◇ Available on tape and reel (8mm Tape).
- ♦ The product itself will remain within RoHS compliant Version.

Descriptions:

This series is available in soft red, orange, yellow, green, blue and white. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the SMT TOP LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications:

- ♦ Automotive: Backlighting in dashboards and switches.
- ♦ Telecommunication: Indicator and backlight in telephone and fax
- ◇ Indicator and backlight for audio and video equipment.
- $\diamond~$ Indicator and backlight in office and family equipment.
- \diamond Flat backlight for LCD's, switches and symbols.
- \diamond Light pipe application.
- \diamond General use.



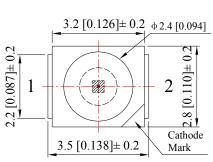
RoHS Compliant

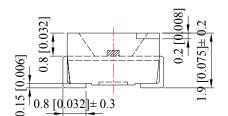
PB Free

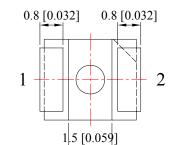




Package Dimension:

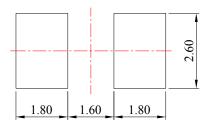






Recommended Soldering Pad Dimensions

Polarity



Unit: mm Tolerance: ± 0.10mm

Part No.	Chip Material	Lens Color	Source Color
R352819-FLWC-UY-200	AlGaInP	Water Clear	Super Yellow

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.10mm (.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.





Absolute Maximum Ratings at $Ta=25^{\circ}C$

Parameters	Symbol	Max.	Unit
Power Dissipation	PD	60	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	100	mA
Continuous Forward Current	IF	25	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature Range	Topr	-40℃ to +80℃	
Storage Temperature Range	Tstg	-40℃ to +85℃	
Soldering Temperature	Tsld	260℃ for 5 Seconds	

Electrical Optical Characteristics at Ta=25℃

Symbol	Min.	Тур.	Max.	Unit	Test Condition		
IV	100	200		mcd	IF=20mA (Note 1)		
20 _{1/2}		120		Deg	IF=20mA (Note 2)		
λр		592		nm	IF=20mA		
λd		590		nm	IF=20mA (Note 3)		
Δλ		15		nm	IF=20mA		
VF	1.60	2.00	2.40	V	IF=20mA		
IR			10	μA	V _R =5V		
	Symbol IV $2\theta_{1/2}$ λp λd $\Delta \lambda$ VF	Symbol Min. IV 100 $2\theta_{1/2}$ λp λd $\Delta \lambda$ ∇F 1.60	Symbol Min. Typ. IV 100 200 $2\theta_{1/2}$ 120 λp 592 λd 590 $\Delta \lambda$ 15 VF 1.60 2.00	Symbol Min. Typ. Max. IV 100 200 $2\theta_{1/2}$ 120 λp 592 λd 590 $\Delta \lambda$ 15 VF 1.60 2.00 2.40	Symbol Min. Typ. Max. Unit IV 100 200 mcd $2\theta_{1/2}$ 120 Deg λp 592 nm λd 15 nm $\Delta \lambda$ 15 nm VF 1.60 2.00 2.40 V		

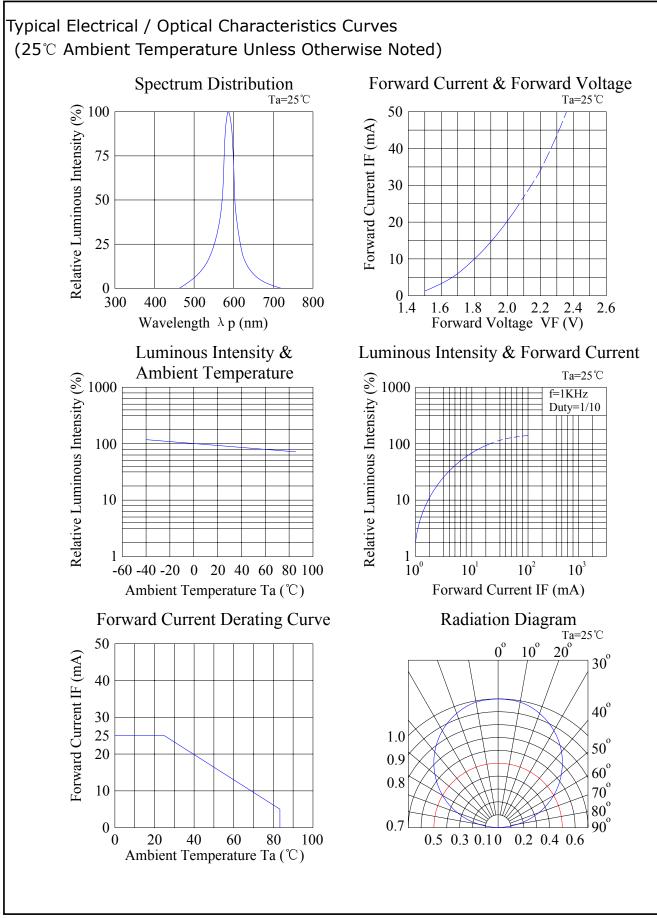
Notes:

1. Luminous Intensity Measurement allowance is \pm 10%.

2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

3. The dominant wavelength (λ d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.









Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5℃, Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H: +100℃ 5min ∫ 10 sec L: -10℃ 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H: +100℃ 15min ∫ 5min L: -40℃ 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100 ℃	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40 ℃	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85℃/85%RH	25pcs	0/1

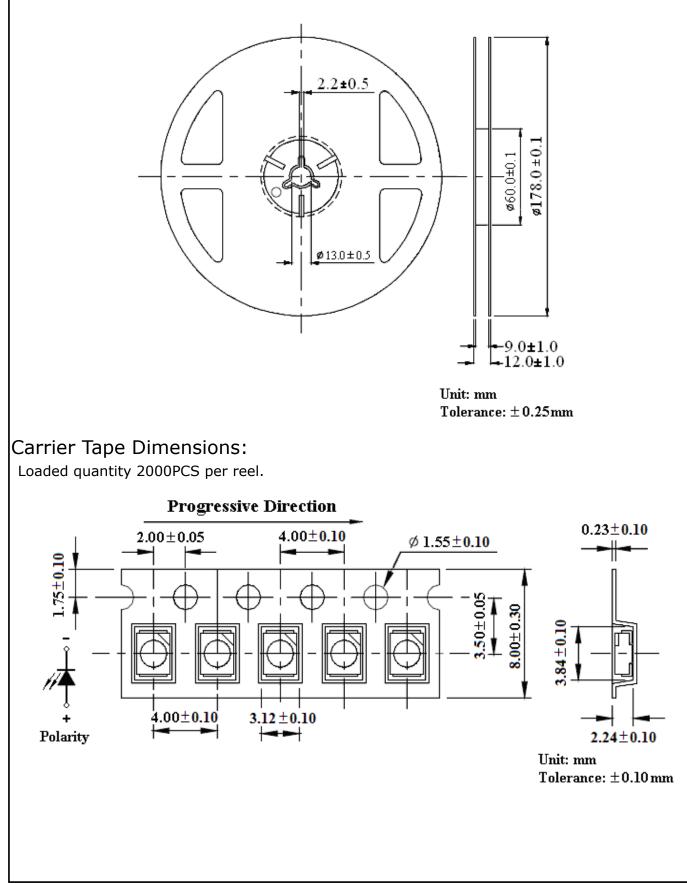
2) Criteria for Judging the Damage:

Item	Symbol	Test Conditions	Criteria for Judgment		
			Min	Max	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

*) F.V.: First Value.



Reel Dimensions:





Please read the following notes before using the product: 1. Over-current-proof Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen). 2. Storage 2.1 Do not open moisture proof bag before the products are ready to use. 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 80° RH or less. 2.3 The LEDs should be used within a year. 2.4 After opening the package, the LEDs should be kept at 30° C or less and 60° RH or less. 2.5 The LEDs should be used within 168 hours (7 days) after opening the package. 2.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours. 3. Soldering Condition When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point. To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions: Soldering Iron Wave Soldering Temperature 300°C Max. Pre-heat 100°C Max. Soldering Time Pre-heat Time 3 sec. Max. 60 sec. Max. Solder Wave 260°C Max. (one time only) Soldering Time 5 sec. Max. Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED. 4. Soldering Iron Each terminal is to go to the tip of soldering iron temperature less than 260 $^\circ$ C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the

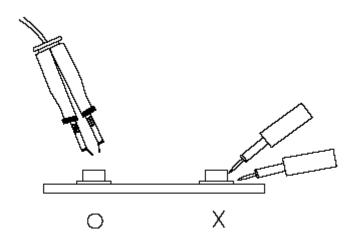
5. Repairing

time of the hand solder.

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.







6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.